- Advanced LinCMOS™ Silicon-Gate Technology
- Easily interfaced to Microprocessors
- On-Chip Data Latches
- Monotonicity Over Entire A/D Conversion Range
- Segmented High-Order Bits Ensure Low-Glitch Output
- Designed to Be interchangeable With Analog Devices AD7524, PMI PM-7524, and Micro Power Systems MP7524
- Fast Control Signaling for Digital Signal Processor Applications Including Interface With SMJ320

| KEY PERFORMANCE SPECIFICATIONS |  |
| :--- | :--- |
| Resolution | 8 Bits |
| Linearity error | $1 / 2 \mathrm{LSB}$ Max |
| Power dissipation at $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ | 5 mW Max |
| Settling time | 100 ns Max |
| Propagation delay | 80 ns Max |

## description

The AD7524M is an Advanced LinCMOS ${ }^{\text {TM }} 8$-bit digital-to-analog converter (DAC) designed for easy interface to most popular microprocessors.

> J PACKAGE (TOP VIEW)

| OUT1 | ${ }_{1} \cup_{16}$ |
| :---: | :---: |
| OUT2 | 215 |
| GND | 314 |
| DB7 | 413 |
| DB6 | 512 |
| DB5 | 611 |
| DB4 | 710 |
| DB3 | 89 |

FK PACKAGE (TOP VIEW)


NC-No internal connection

The AD7524M is an 8-bit multiplying DAC with input latches and with a load cycle similar to the write cycle of a random access memory. Segmenting the high-order bits minimizes glitches during changes in the most-significant bits, which produce the highest glitch impulse. The AD7524M provides accuracy to $1 / 2$ LSB without the need for thin-film resistors or laser trimming, while dissipating less than 5 mW typically.
Featuring operation from a 5-V to 15-V single supply, the AD7524M interfaces easily to most microprocessor buses or output ports. Excellent multiplying (2 or 4 quadrant) makes the AD7524M an ideal choice for many microprocessor-controlled gain-setting and signal-control applications.
The AD7524M is characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
AVAILABLE OPTIONS

| $\mathbf{T A}_{\mathbf{A}}$ | PACKAGE |  |
| :---: | :---: | :---: |
|  | CERAMIC CHIP <br> CARRIER <br> (FK) | CERAMIC DIP |
| (J) |  |  |

## AD7524M

Advanced LinCMOSTM 8-BIT MULTIPLYING
DIGITAL-TO-ANALOG CONVERTER
SGLS028A - SEPTEMBER 1989 - REVISED MARCH 1995

## functional block diagram


operating sequence


# AD7524M <br> Advanced LinCMOSTM 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER <br> SGLS028A - SEPTEMBER 1989 - REVISED MARCH 1995 

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) ${ }^{\dagger}$

$$
\begin{aligned}
& \text { Supply voltage range, } \mathrm{V}_{\mathrm{DD}} \text {...................................................................... }-0.3 \mathrm{~V} \text { to } 17 \mathrm{~V} \\
& \text { Voltage between } \mathrm{R}_{\text {FB }} \text { and GND .................................................................................... } 25 \mathrm{~V}
\end{aligned}
$$

$$
\begin{aligned}
& \text { Reference voltage range, } \mathrm{V}_{\text {ref }} \text {. .................................................................................... } 25 \mathrm{~V} \\
& \text { Peak digital input current, } I_{I} \ldots \ldots \ldots . \text {....................................................................... } 10 \mu \mathrm{~A}
\end{aligned}
$$

$$
\begin{aligned}
& \text { Case temperature for } 60 \text { seconds, } \mathrm{T}_{\mathrm{C}} \text { : FK package ................................................. } 260^{\circ} \mathrm{C}
\end{aligned}
$$

$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
recommended operating conditions

|  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\text {DD }}$ | 4.75 | 5 | 5.25 | 14.5 | 15 | 15.5 | V |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ |  | $\pm 10$ |  |  | $\pm 10$ |  | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | 2.4 |  |  | 13.5 |  |  | V |
| Low-level input volage, $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 |  |  | 1.5 | V |
| $\overline{\mathrm{CS}}$ setup time, $\mathrm{t}_{\text {Su(CS }}$ | 40 |  |  | 40 |  |  | ns |
| $\overline{\mathrm{CS}}$ hold time, $\mathrm{th}^{\text {(CS) }}$ | 0 |  |  | 0 |  |  | ns |
| Data bus input setup time, $\mathrm{t}_{\text {su }}(\mathrm{D})$ | 25 |  |  | 25 |  |  | ns |
| Data bus input hold time, th(D) | 10 |  |  | 10 |  |  | ns |
| Pulse duration, $\overline{\mathrm{WR}}$ low, $\mathrm{t}_{\mathrm{w}}(\mathrm{WR})$ | 40 |  |  | 40 |  |  | ns |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | -55 |  | 125 | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |

AD7524M
Advanced LinCMOSTM 8-BIT MULTIPLYING
SGLS028A - SEPTEMBER 1989 - REVISED MARCH 1995
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  |  | D $=5 \mathrm{~V}$ |  | = 15 V | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP MAX | MIN | TYP MAX |  |
|  | High-level input current |  |  |  |  | Full-range |  | 10 |  | 10 | $\mu \mathrm{A}$ |
| 1 H |  |  | $V_{I}=V_{\text {DD }}$ | $25^{\circ} \mathrm{C}$ |  | 1 |  | 1 |  |  |
|  | Low-level input current |  | $\mathrm{V}_{1}=0$ | Full-range |  | -10 |  | -10 | $\mu \mathrm{A}$ |  |
|  |  |  | $25^{\circ} \mathrm{C}$ |  | -1 |  | -1 |  |  |
| Ipkg | Output leakage current | OUT1 |  | $\begin{aligned} & \frac{\mathrm{DB} 0-\mathrm{DB7} \text { at } 0,}{\mathrm{WR} \text { and } \overline{\mathrm{CS}} \text { at } 0 \mathrm{~V}}, \end{aligned}$ | Full-range |  | $\pm 400$ |  | $\pm 200$ | nA |  |
|  |  |  | $\mathrm{V}_{\text {ref }}= \pm 10 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ |  | $\pm 50$ |  | $\pm 50$ |  |  |  |
|  |  | OUT2 | $\begin{aligned} & \frac{\mathrm{DB} 0-\mathrm{DB7} \text { at } \mathrm{V}_{\mathrm{DD}}}{\mathrm{WR} \text { and } \overline{\mathrm{CS}} \text { at } 0}, \end{aligned}$ | Full-range |  | $\pm 400$ |  | $\pm 200$ |  |  |  |
|  |  |  | $\mathrm{V}_{\text {ref }}= \pm 10 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ |  | $\pm 50$ |  | $\pm 50$ |  |  |  |
| IDD | Supply current | Quiescent | DB0-DB7 at $\mathrm{V}_{\text {IH }}$ min or $\mathrm{V}_{\text {IL }}$ max |  |  | 2 |  | 2 | mA |  |  |
|  |  | Standby | DB0-DB7 at 0 V or V | Full-range |  | 500 |  | 500 | $\mu \mathrm{A}$ |  |  |
|  |  | Standby | DB0-DB7 atovorvod | $25^{\circ} \mathrm{C}$ |  | 100 |  | 100 |  |  |  |
| kSVS | Supply voltage sensitivity, $\Delta$ gain/ $\Delta V_{D D}$ |  | VD $=10 \%$ | Full-range |  | 0.16 |  | 0.04 | \%/\% |  |  |
|  |  |  | DD $=10 \%$ | $25^{\circ} \mathrm{C}$ |  | 0.0020 .02 |  | 0.0010 .02 | pF |  |  |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, DB0-DB7, $\overline{W R}, \overline{C S}$ |  | $V_{l}=0$ |  |  | 5 |  | 5 | pF |  |  |
| Co | Output capacitance | OUT1 | DB0-DB7 at $0, \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V |  |  | 30 |  | 30 | pF |  |  |
|  |  | OUT2 |  |  |  | 120 |  | 120 |  |  |  |
|  |  | OUT1 | DB0-DB7 at $\mathrm{V}_{\mathrm{DD}}, \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V |  |  | 120 |  | 120 |  |  |  |
|  |  | OUT2 |  |  |  | 30 |  | 30 |  |  |  |
| Reference input impedance (REF to GND) |  |  |  |  | 5 | 20 | 5 | 20 | k $\Omega$ |  |  |

operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN MAX |  |
| Linearity error |  |  | $\pm 0.2$ | $\pm 0.2$ | \%FSR |
| Gain error | See Note 1 | Full range | $\pm 1.4$ | $\pm 0.6$ | \%FSR |
|  |  | $25^{\circ} \mathrm{C}$ | $\pm 1$ | $\pm 0.5$ |  |
| Settling time (to 1/2 LSB) | See Note 2 |  | 100 | 100 | ns |
| Propagation delay from digital input to $90 \%$ of final analog output current | See Note 2 |  | 80 | 80 | ns |
| Feedthrough at OUT1 or OUT2 | $V_{\text {ref }}= \pm 10 \mathrm{~V}$ ( 100 kHz sinewave), $\overline{W R}$ and $\overline{C S}$ at $0, \quad D B 0-D B 7$ at 0 | Full range | 0.5 | 0.5 | \%FSR |
|  |  | $25^{\circ} \mathrm{C}$ | 0.25 | 0.25 |  |
| Temperature coefficient of gain | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ to $\mathrm{t}_{\text {min }}$ or $\mathrm{t}_{\text {max }}$ |  | $\pm 0.004$ | $\pm 0.001$ | $\begin{aligned} & \hline \text { \%FSR/ } \\ & { }^{\circ} \mathrm{C} / \end{aligned}$ |

NOTES: 1. Gain error is measured using the internal feedback resistor. Nominal Full Scale Range (FSR) $=\mathrm{V}_{\text {ref }}-1$ LSB.
2. OUT1 load $=100 \Omega, C_{e x t}=13 \mathrm{pF}, \overline{W R}$ at $0 \mathrm{~V}, \overline{\mathrm{CS}}$ at $0 \mathrm{~V}, \mathrm{DB} 0-\mathrm{DB7}$ at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .

## PRINCIPLES OF OPERATION

The AD7524M is an 8-bit multiplying D/A converter consisting of an inverted R-2R ladder, analog switches, and data input latches. Binary weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state. The high-order bits are decoded and these decoded bits, through a modification in the R-2R ladder, control three equally weighted current sources. Most applications only require the addition of an external operational amplifier and a voltage reference.
The equivalent circuit for all digital inputs low is seen in Figure 1. With all digital inputs low, the entire reference current, $I_{\text {ref }}$, is switched to OUT2. The current source $1 / 256$ represents the constant current flowing through the termination resistor of the R-2R ladder, while the current source $\mathrm{I}_{\mathrm{kg}}$ represents leakage currents to the substrate. The capacitances appearing at OUT1 and OUT2 are dependent upon the digital input code. With all digital inputs high, the off-state switch capacitance ( 30 pF maximum) appears at OUT2 and the on-state switch capacitance ( 120 pF maximum) appears at OUT1. With all digital inputs low, the situation is reversed as shown in Figure 1. Analysis of the circuit for all digital inputs high is similar to Figure 1 ; however, in this case, I Iref would be switched to OUT1.

Interfacing the AD7524M D/A converter to a microprocessor is accomplished via the data bus and the $\overline{\mathrm{CS}}$ and $\overline{W R}$ control signals. When $\overline{C S}$ and $\overline{W R}$ are both low, the AD7524M analog output responds to the data activity on the DB0-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the CS signal or WR signal goes high, the data on the DB0-DB7 inputs are latched until the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled regardless of the state of the $\overline{\mathrm{WR}}$ signal.
The AD7524M is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2-quadrant or 4-quadrant multiplication are shown in Figures 2 and 3. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.

## PRINCIPLES OF OPERATION



Figure 1. AD7524M Equivalent Circuit With All Digital Inputs Low


Figure 2. Unipolar Operation (2-Quadrant Multiplication)


Figure 3. Bipolar Operation (4-Quadrant Operation)
NOTES: A. $R_{A}$ and $R_{B}$ used only if gain adjustment is required.
B. $C$ phase compensation $(10-15 \mathrm{pF})$ is required when using high-speed amplifiers to prevent ringing or oscillation.

## PRINCIPLES OF OPERATION

Table 1. Unipolar Binary Code

| DIGITAL INPUT <br> (see NOTE 3) |  | ANALOG OUTPUT |  |
| :---: | :--- | :--- | :---: |
| MSB | LSB |  |  |
| 11111111 |  | $-\mathrm{V}_{\text {ref }}(255 / 256)$ |  |
| 10000001 | $-\mathrm{V}_{\text {ref }}(129 / 256)$ |  |  |
| 10000000 | $-\mathrm{V}_{\text {ref }}(128 / 256)=-\mathrm{V}_{\text {ref }} / 2$ |  |  |
| 01111111 | $-\mathrm{V}_{\text {ref }}(127 / 256)$ |  |  |
| 00000001 | $-\mathrm{V}_{\text {ref }}(1 / 256)$ |  |  |
| 00000000 | 0 |  |  |

NOTES: 3. LSB = 1/256 ( $\mathrm{V}_{\text {ref }}$ ).
Table 2. Bipolar (Offset Binary) Code

| DIGITAL INPUT <br> (see NOTE 4) |  | ANALOG OUTPUT |
| :--- | :--- | :--- |
| MSB | LSB |  |
| 11111111 |  | $\mathrm{~V}_{\text {ref }}(127 / 128)$ |
| 10000001 | $\mathrm{~V}_{\text {ref }}(128)$ |  |
| 10000000 | 0 |  |
| 0111111 | $-\mathrm{V}_{\text {ref }}(128)$ |  |
| 00000001 | $-\mathrm{V}_{\text {ref }}(127 / 128)$ |  |
| 00000000 | $-\mathrm{V}_{\text {ref }}$ |  |

NOTES: 4. LSB $=1 / 128\left(V_{\text {ref }}\right)$.
microprocessor interfaces


Figure 4. AD7524M-Z-80A Interface

## PRINCIPLES OF OPERATION



Figure 5. AD7524M-6800 Interface


Figure 6. AD7524M-8051 Interface

## PACKAGING INFORMATION

| Orderable Device | Status $^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $5962-87700012 A$ | OBSOLETE | LCCC | FK | 20 | TBD | Call TI | Call TI |
| $5962-8770001 E A$ | OBSOLETE | CDIP | J | 16 | TBD | Call TI | Call TI |
| AD7524MFKB | OBSOLETE | LCCC | FK | 20 | TBD | Call TI | Call TI |
| AD7524MJ | OBSOLETE | CDIP | J | 16 | TBD | Call TI | Call TI |
| AD7524MJB | OBSOLETE | CDIP | $J$ | 16 | TBD | Call TI | Call TI |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
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PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no $\mathbf{S b} / \mathrm{Br}$ ): Tl defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony ( Sb ) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

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